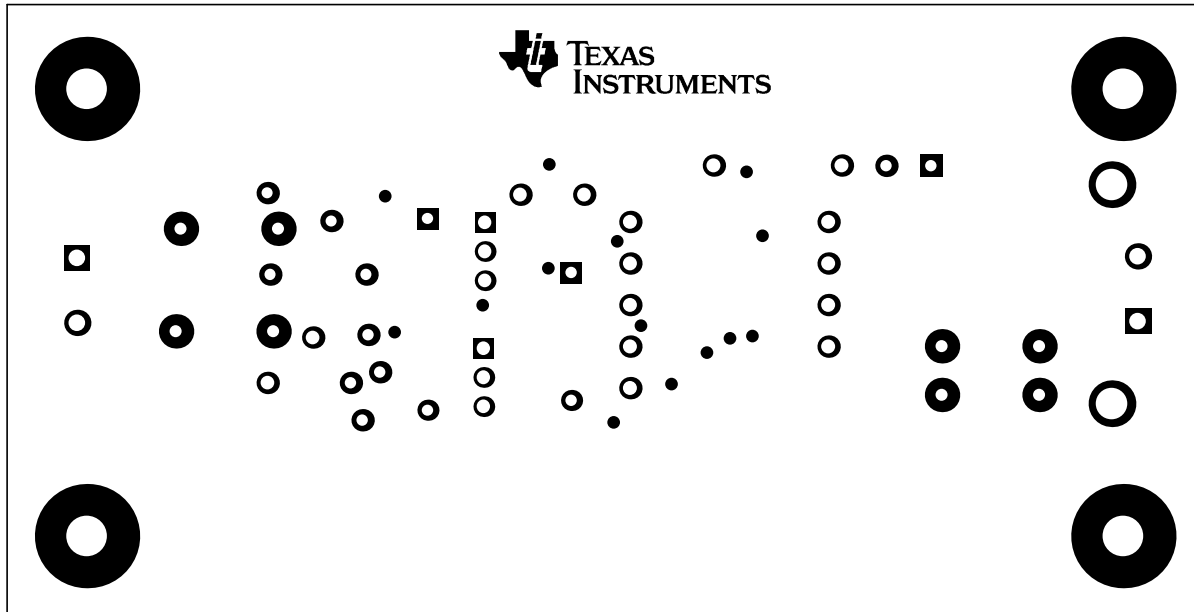
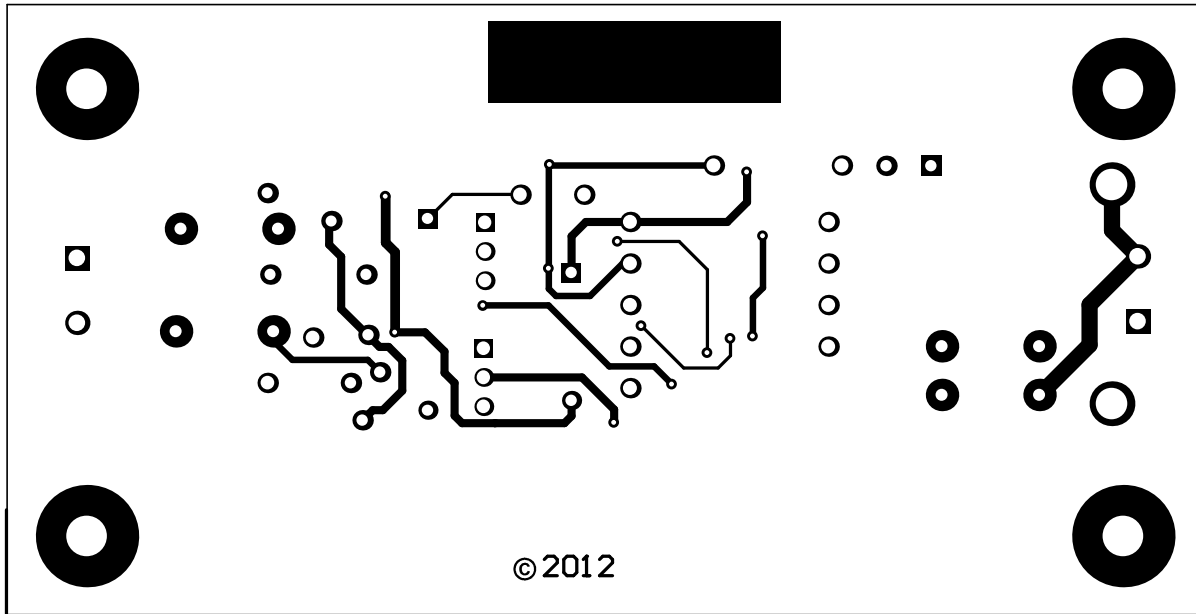


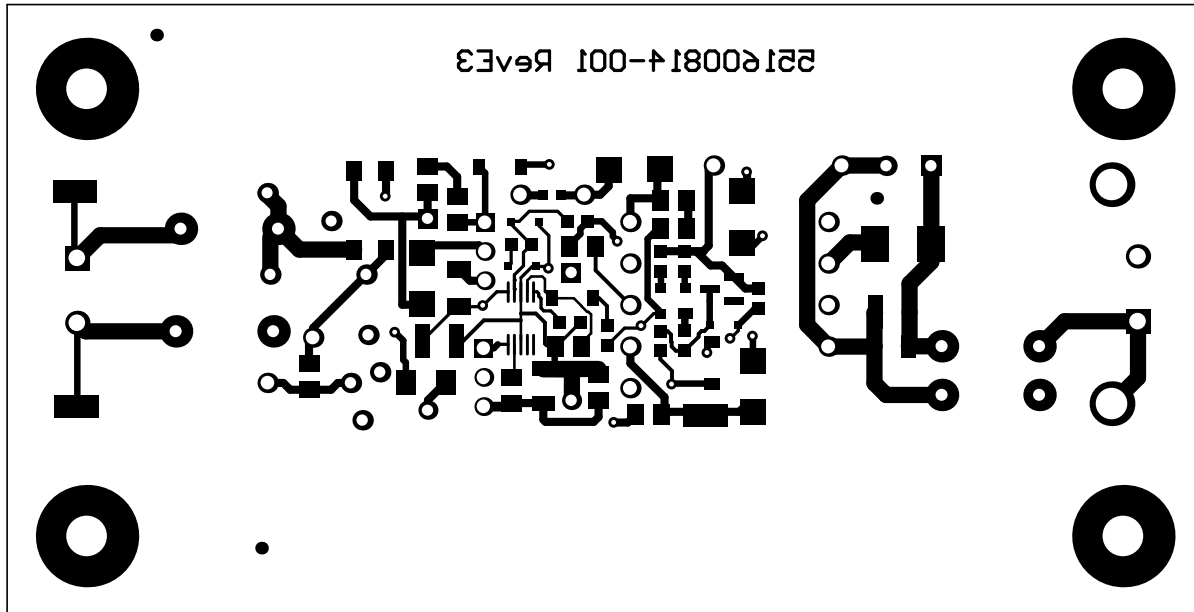
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LAYER NAME =	ARTWORK # = 600814-001 E3	TEXAS INSTRUMENTS
PLOT NAME = Top Overlay	GENERATED	: 7/11/2012 10:53:34



ALL ARTWORK VIEWED FROM TOP SIDE	PROJECT NAME = TPS92310-DIM		
LAYER NAME =	ARTWORK # = 600814-001 E3	TEXAS INSTRUMENTS	
PLOT NAME = Top Solder Mask	GENERATED	: 7/11/2012	10:53:35

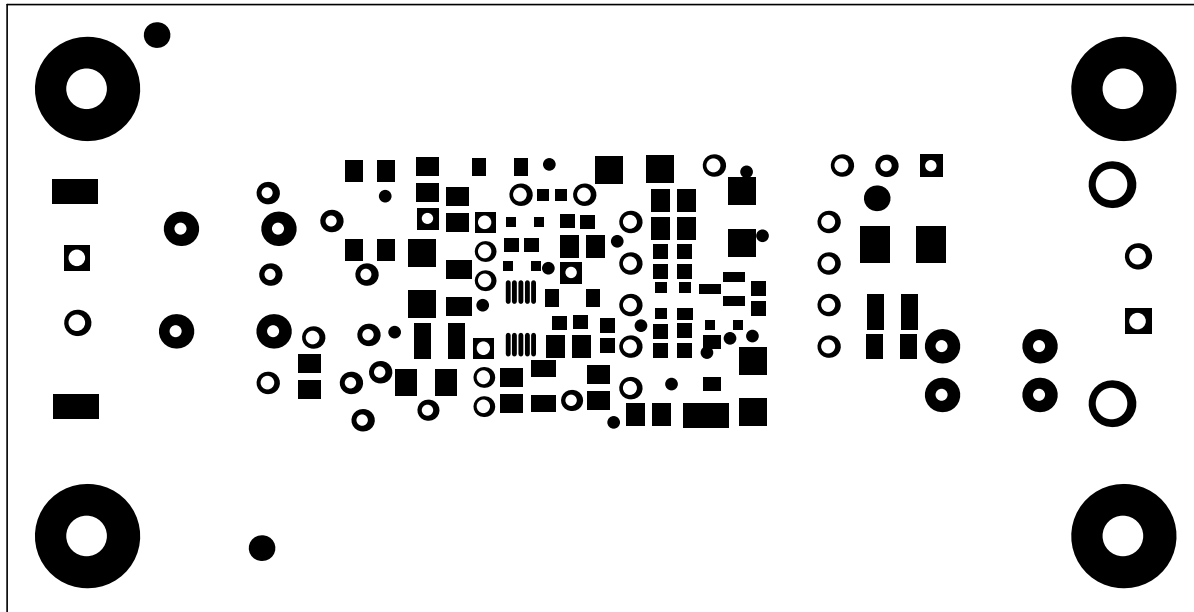


ALL ARTWORK VIEWED FROM TOP SIDE	PROJECT NAME = TPS92310-DIM		
LAYER NAME =	ARTWORK # = 600814-001 E3	TEXAS INSTRUMENTS	
PLOT NAME = Top Layer	GENERATED	: 7/11/2012	10:53:35

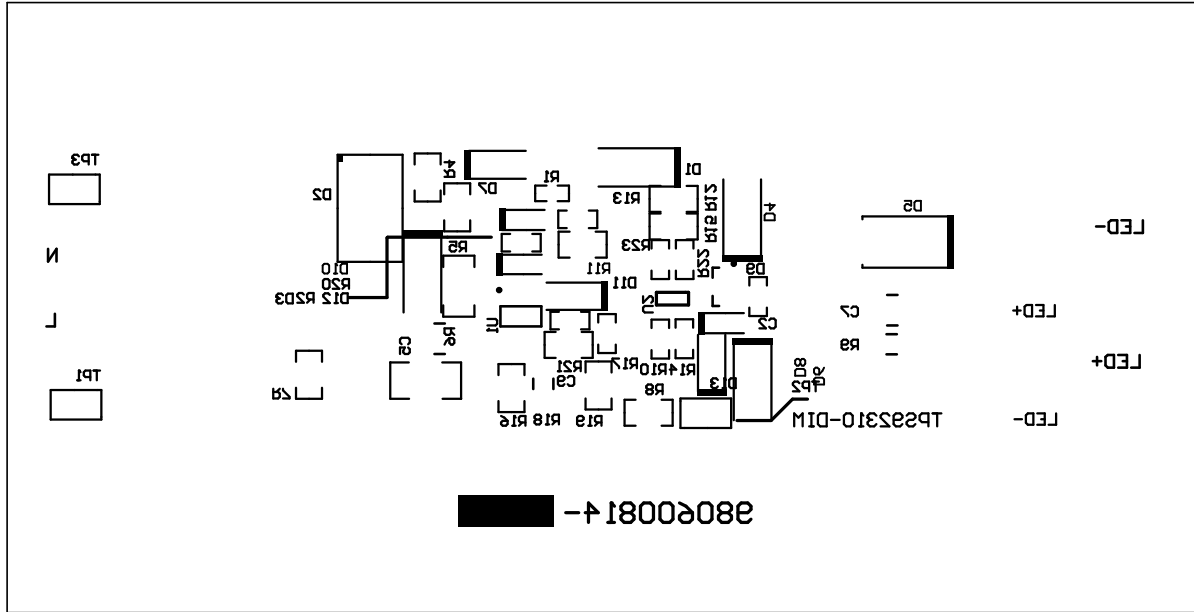


521900814-001 RevE3

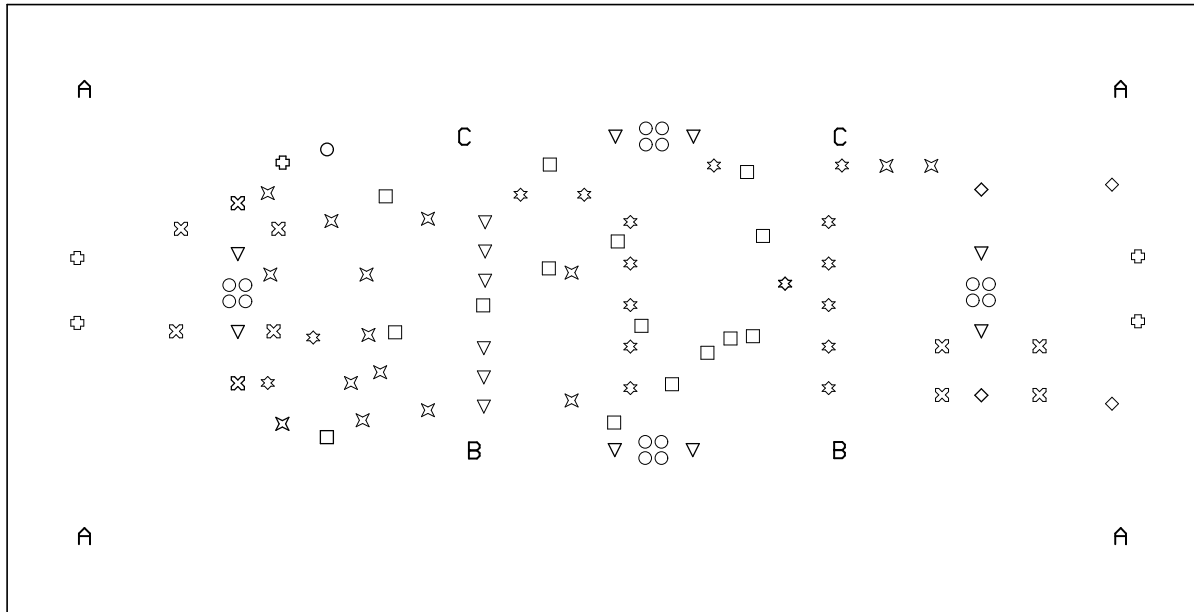
ALL ARTWORK VIEWED FROM TOP SIDE	PROJECT NAME = TPS92310-DIM		
LAYER NAME =	ARTWORK # = 600814-001 E3	TEXAS INSTRUMENTS	
PLOT NAME = Bottom Layer		GENERATED : 7/11/2012	10:53:36



ALL ARTWORK VIEWED FROM TOP SIDE	PROJECT NAME = TPS92310-DIM		
LAYER NAME =	ARTWORK # = 600814-001 E3	TEXAS INSTRUMENTS	
PLOT NAME = Bottom Solder Mask	GENERATED	: 7/11/2012	10:53:36



ALL ARTWORK VIEWED FROM TOP SIDE	PROJECT NAME = TPS92310-DIM	
LAYER NAME =	ARTWORK # = 600814-001 E3	TEXAS INSTRUMENTS
PLOT NAME = Bottom Overlay	GENERATED	: 7/11/2012 10:53:36



ALL ARTWORK VIEWED FROM TOP SIDE	PROJECT NAME = TPS92310-DIM		
LAYER NAME =	ARTWORK # = 600814-001 E3	TEXAS INSTRUMENTS	
PLOT NAME = Drill Drawing		GENERATED : 7/11/2012	10:53:37



ALL ARTWORK VIEWED FROM TOP SIDE	PROJECT NAME = TPS92310-DIM		
LAYER NAME = M2 Board Dimensions	ARTWORK # = 880600814-001 E3	TEXAS INSTRUMENTS	
PLOT NAME = Board Dimensions		GENERATED	: 7/11/2012 10:53:39

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